

GigaDevice Semiconductor Inc.

GD32W51x TrustZone Development Guide

Application Note

AN103

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1. Introduction

This article describes developing the TrustZone program on the GD32W51x series. The TrustZone security attribute is the main ARMv8-M extension, which provides hardware security separation and protection. The sample code is also divided into two parts, security and non-security. The development process and key points for Keil and IAR are described.

In this article, the GD32W515P-EVAL development board was used, the chip model was GD32W515PIQ6, and the Cortex-M33 kernel with TrustZone was used, with max frequency up to 180MHz. The TrustZone security is activated by the TZEN option bit in the EFUSE_TZCTL register or the TZEN option bit in the option byte. The sample code is provided in 'GD32W515P_EVAL_Demo_Suites / 23_Trustzone' and is provided by the software package in GD32MCU.COM.

Applicable product: GD32W51x series

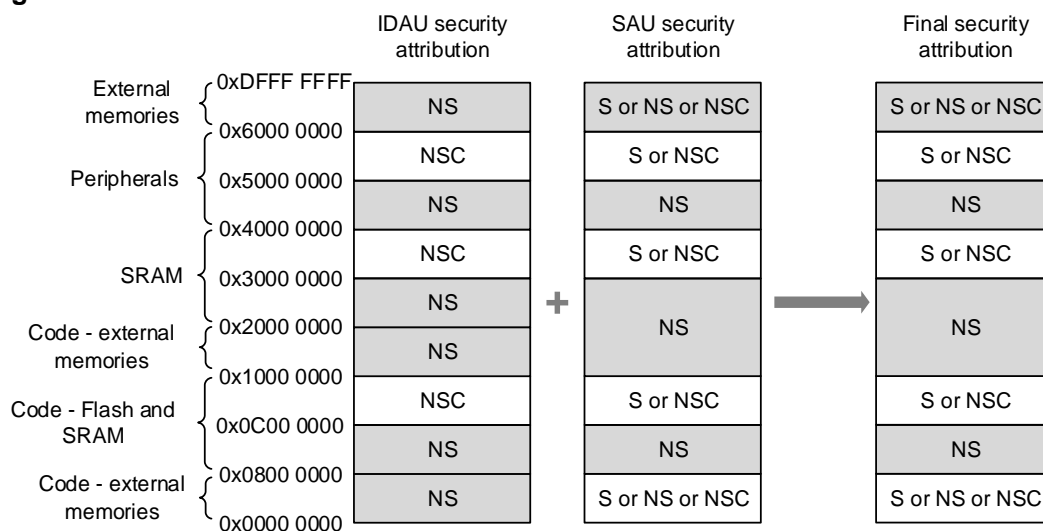
2. TrustZone introduction

The M33 kernel with TrustZone has both secure and non-secure states, which use a separate set of kernel registers and Systick. Memory is classified into secure (S), non-secure callable (NSC), and non-secure (NS) domain. A secure domain can access a non-secure domain, and a non-secure can only access a non-secure callable(in secure code), providing hardware protection for access. When TrustZone is enabled, SAU (security attribution unit) and IDAU (implementation defined attribution unit) are used together to set the security attribute of the memory address. The final security level is the attribute of higher security level defined in SAU and IDAU (S>NSC>NS). See [Figure 2-1. Example of memory map security attribution vs SAU configuration regions](#).

IDAU provides a hardware partition of non-secure (NS) and non-secure Callable (NSC) security attributes, which cannot be changed by software, and memory mapped partitions refer to Section 1.4 Memory Mapping in the GD32W51x_User manual.

SAU can be software-configured with up to 8 security attribute zones, which can be made secure (S), non-secure (NS), or non-secure callable (NSC).

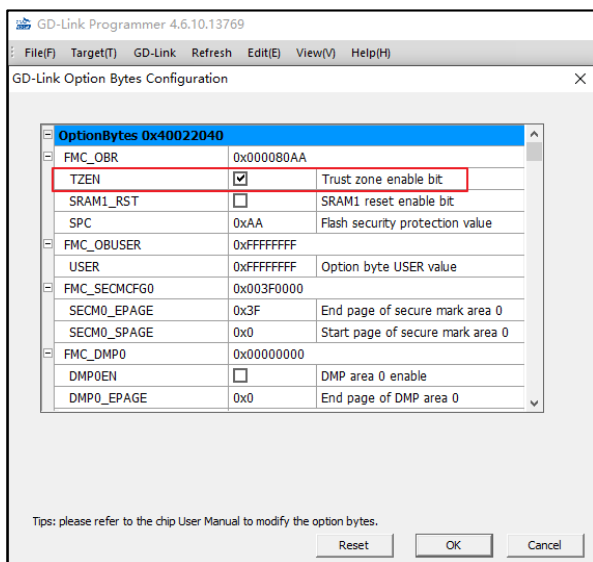
Figure 2-1. Example of memory map security attribution vs SAU configuration regions



GD32W51x uses TrustZone protection controller union (TZPCU) to manage the security attributes of peripherals, SRAM, and flash memory. TZPCU provides unauthorized access control, working with the kernel to achieve full features of TrustZone.

Ensure that the TZEN bit in the EFUSE_TZCTL register or the TZEN bit in the option byte is enabled before using TrustZone or TZPCU. Using GD-Link Programmer to enable TZEN bit in option bytes, as shown in [Figure 2-2. Enable TrustZone using the GD-Link Programmer](#). The GD-Link Programmer can be obtained from GD32MCU.COM.

Figure 2-2. Enable TrustZone using the GD-Link Programmer



3. Software development

This article uses two development environments, MDK-ARM v5.28.0.0 and IAR v8.50.9. Please ensure that the corresponding software and device package are correctly installed. The software can be obtained from the official website of **KEIL** and **IAR**. The device package (GD32W51x_AddOn) can be obtained from GD32MCU.COM.

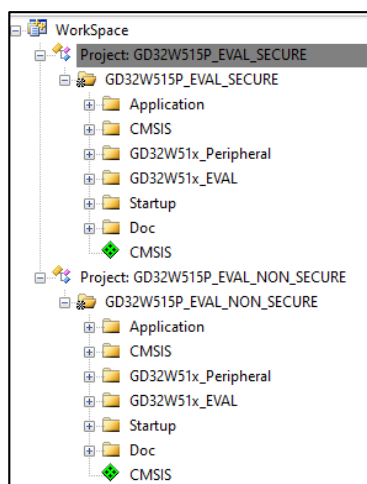
The sample project has secure and non-secure projects that use different Flash and SRAM. The secure project uses the first 256KB in the FMC (starting address 0x0C000000, size 0x40000), and the memory uses SRAM0 blocks (starting address 0x30000000, size 0x10000). The non-secure project uses the last 1792KB in the FMC (starting address 0x08040000, size 0x1C0000) and the memory uses SRAM1 block (starting address 0x20010000, size 0x10000).

3.1. Developing TrustZone in Keil

Multiple project can be used to develop two projects at the same time, as shown in [Figure 3-1. Keil project file structure](#), project path:

GD32W51x_Demo_Suites\GD32W515P_EVAL_Demo_Suites\Projects\23_Trustzone\MDK-ARM\GD32W515P_EVAL_TRUSTZONE.uvmpw

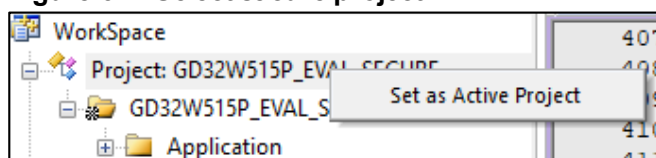
Figure 3-1. Keil project file structure



3.1.1. Secure Project

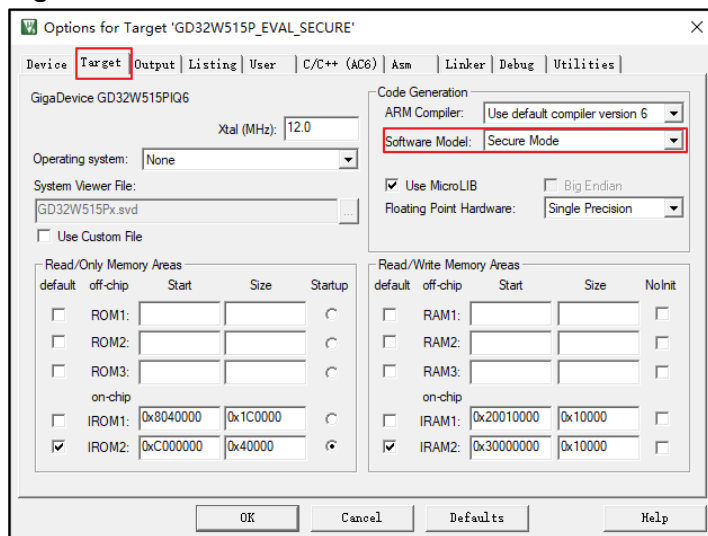
1. Select secure project as current project, as shown in [Figure 3-2. Select secure project](#).

Figure 3-2. Select secure project



2. In Project/Options for Target/Target, select Code Generation/Software Model as Secure Mode, as shown in [Figure 3-3. Select Secure mode](#).

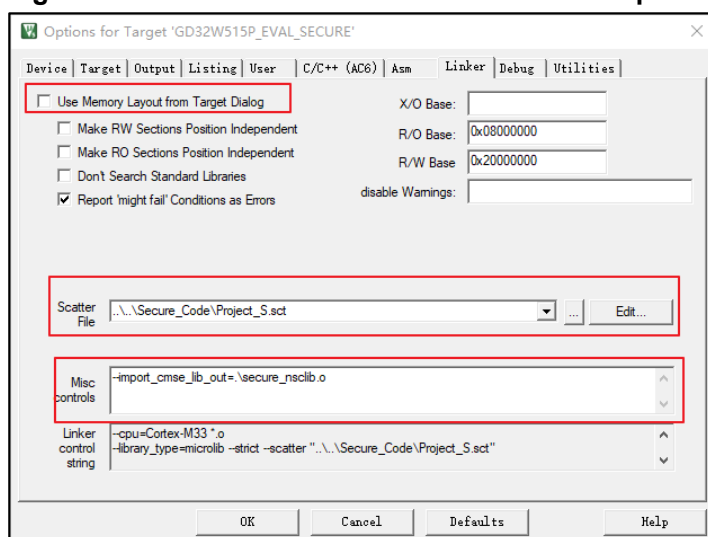
Figure 3-3. Select Secure mode



3. Secure code and non-secure code use different Flash and SRAM, and use a scattered load file to assign the Flash and SRAM for secure code. In Project/Options for Target/Linker, select not to assign addresses using the Target interface, select scatter load file, and set the output library for NSC functions. See [Figure 3-4. Select scattered load file and NSC output library](#).

The output command is `--import_cmse_lib_out=.secure_nsclib.o`. The compiler will compile the code at compile time with `__attribute__((cmse_nonsecure_entry))` identifying code into `.secure_nsclib.o`. Non-secure code can access function of `secure_nsclib.o`.

Figure 3-4. Select scattered load file and NSC output library



4. The secure project uses Flash address 0x0C000000 with size 0x40000 and SRAM address 0x30000000 with size 0x10000. NSC function is assigned to address 0x0C03E000 and size is 0x00002000. Project_S.sct code is shown in [Table 3-1. Project_S.sct code](#).

Table 3-1. Project_S.sct code

```

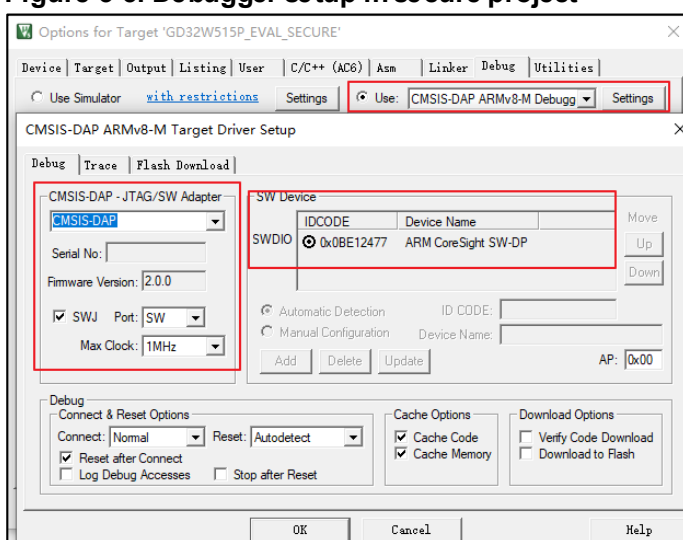
LR_IROM1 0x0C000000 0x00040000 { ; load region size_region
  ER_IROM1 0x0C000000 0x0003E000 { ; load address = execution address
    *.o (RESET, +First)
    *(InRoot$$Sections)
    .ANY (+RO)
    .ANY (+XO)
  }
  RW_IRAM2 0x30000000 0x00010000 { ; RW data
    .ANY (+RW +ZI)
  }
}

LR_IROM2 0x0C03E000 0x00002000 {
  ER_IROM2 0x0C03E000 0x00002000 { ; load address = execution address
    *(Veneer$$CMSE) ; check with partition.h
  }
}

```

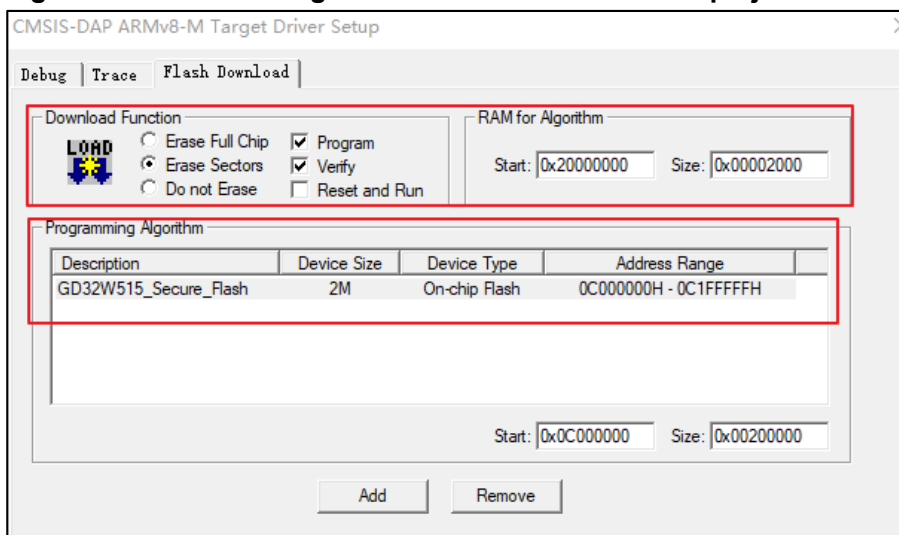
5. Use GD-Link for debugging and downloading. Connect GD-Link interface of Eval-board directly to PC-USB. Select CMSIS-DAP ARMv8-M Debugger under Project/Options for Target/Debug. Identify the debugger ID in Settings, use the SW interface and set the maximum clock to 1MHz. See [Figure 3-5. Debugger setup in secure project](#).

Figure 3-5. Debugger setup in secure project



6. Under Flash Download TAB, select Erase Sectors and uncheck Reset and Run. Add programming algorithm GD32W515_Secure_Flash. GD32W515_Secure_Flash is provided by the installed device package. See [Figure 3-6. Download algorithm and function in secure project](#).

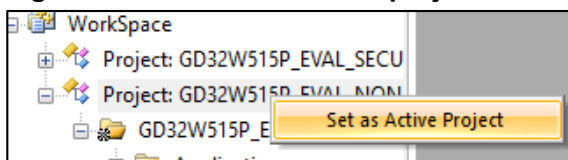
Figure 3-6. Download algorithm and function in secure project



3.1.2. Non-secure Project

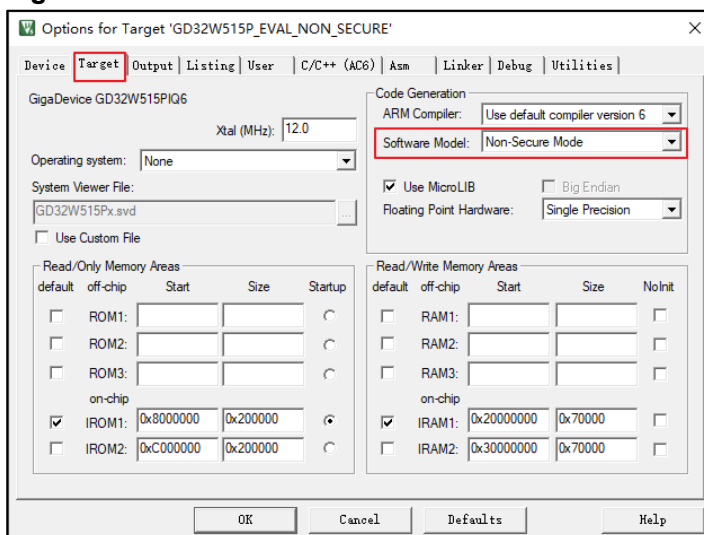
1. Select non-secure project as current project, as shown in [Figure 3-7. Select non-secure project](#).

Figure 3-7. Select non-secure project



2. In Project/Options for Target/Target TAB, select Code Generation/Software Model as Non-secure Mode, as shown in [Figure 3-8. Select non-secure mode](#).

Figure 3-8. Select non-secure mode

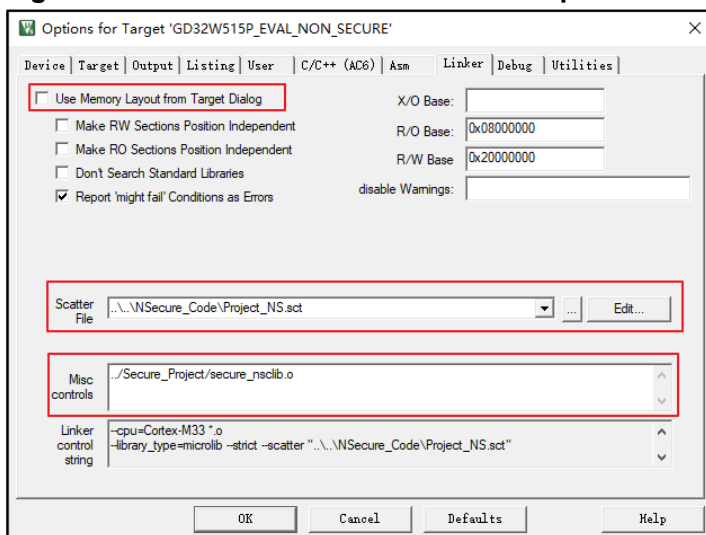


3. Secure code and non-secure code use different Flash and SRAM, and use a distributed load file to assign the Flash and SRAM for secure code. In Project/Options for Target/Linker,

select not to assign addresses using the Target interface, select the scattered load file, and use the NSC function library exported by the Security Project. See [Figure 3-9. Select scattered load file and import NSC library](#).

Library import command `../Secure_Project/secure_nsclib.o`, non-secure project can directly call the `__attribute__((cmse_nonsecure_entry))` identification code in the security project.

Figure 3-9. Select scattered load file and import NSC library



4. Non-secure code uses Flash address `0x08040000` with size `0x001C0000` and SRAM address `0x20010000` with size `0x10000`. Project_NS.sct code is shown in [Table 3-2. Project_NS.sct code](#).

Table 3-2. Project_NS.sct code

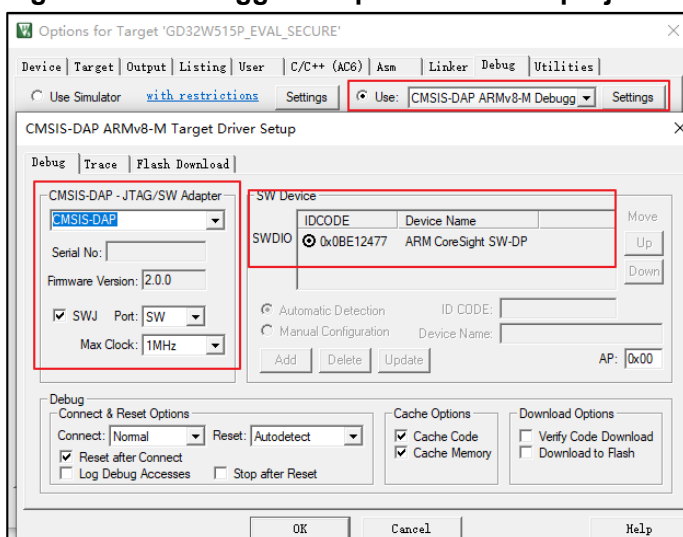
```

LR_IROM1 0x08040000 0x001C0000 { ; load region size_region
  ER_IROM1 0x08040000 0x001C0000 { ; load address = execution address
    *.o (RESET, +First)
    *(InRoot$$Sections)
    .ANY (+RO)
    .ANY (+XO)
  }
  RW_IRAM1 0x20010000 0x00010000 { ; RW data
    .ANY (+RW +ZI)
  }
}

```

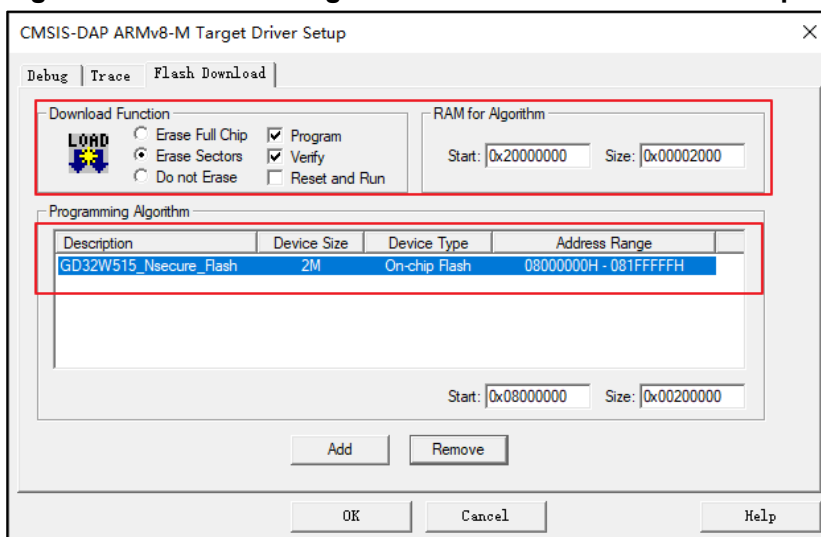
5. Use GD-Link for debugging and downloading. Connect GD-Link interface of Eval-board directly to PC-USB. Select CMSIS-DAP ARMv8-M Debugger under Project/Options for Target/Debug. Identify the debugger ID in Settings, use the SW interface and set the maximum clock to 1MHz. See [Figure 3-10. Debugger setup in non-secure project](#).

Figure 3-10. Debugger setup in non-secure project



6. Under Flash Download TAB, select Erase Sectors and uncheck Reset and Run. Add programming algorithm GD32W515_Nsecure_Flash. GD32W515_Nsecure_Flash is provided by the installed device package. See [Figure 3-11. Download algorithm and function in non-secure project](#).

Figure 3-11. Download algorithm and function in non-secure project

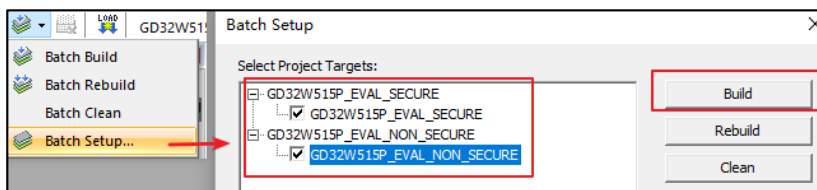


3.1.3. Compile Project

Firstly compile secure project and then non-secure project. Non-secure project need secure_nsclib.o library generated in secure project. Compile the secure and insecure projects in order.

Batch setup can also compile two projects in order, as shown in [Figure 3-12. Compile Project](#). Select two projects and click Build. The order is determined by project directory sequence, which can be modified by project/Manage/Multi-Project Workspace.

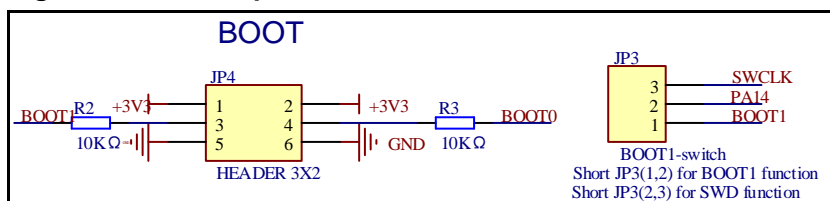
Figure 3-12. Compile Project



3.1.4. Download Project

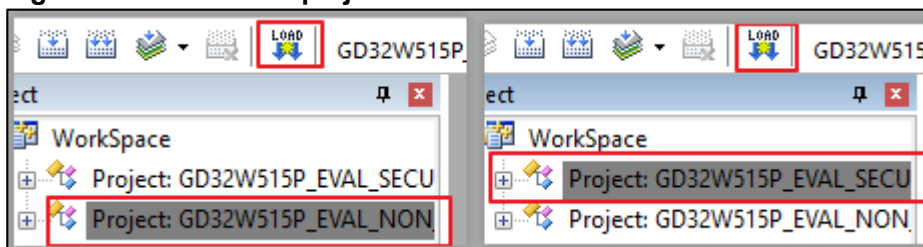
Set up Eval-board correctly before downloading code. JP4 (BOOT0/BOOT1) connects to L. MCU will boot from the secure code. JP3 connects to SWD. See [Figure 3-13. Boot option](#). JP21 connects to USART for printf. Connect Eval-board GD-Link and USART to PC, and ensure that software drivers are correctly installed.

Figure 3-13. Boot option



Firstly download non-secure code and then secure code. MCU always boots from secure code and jumps to non-secure code. See [Figure 3-14. Download project](#).

Figure 3-14. Download project



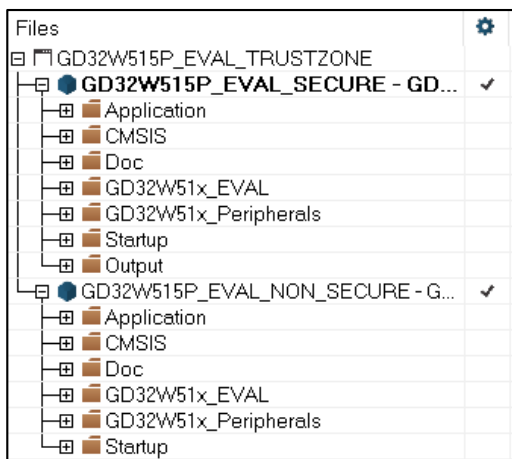
Reset and Run are not checked in the Flash Download option. Press manually Reset button to restart MCU. Two messages will be printed and two LED lights flash respectively.

3.2. Developing TrustZone in IAR

Two projects can be developed at the same time using multiple project methods. The file structure is shown in [Figure 3-15. IAR project file structure](#), project path:

GD32W51x_Demo_Suites\GD32W515P_EVAL_Demo_Suites\Projects\23_Trustzone\EWA
RM\GD32W515P_EVAL_TRUSTZONE.eww

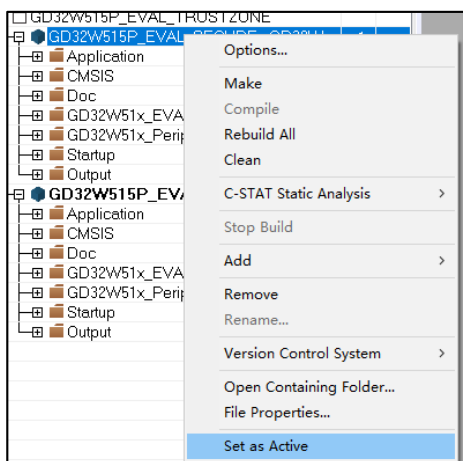
Figure 3-15. IAR project file structure



3.2.1. Secure Project

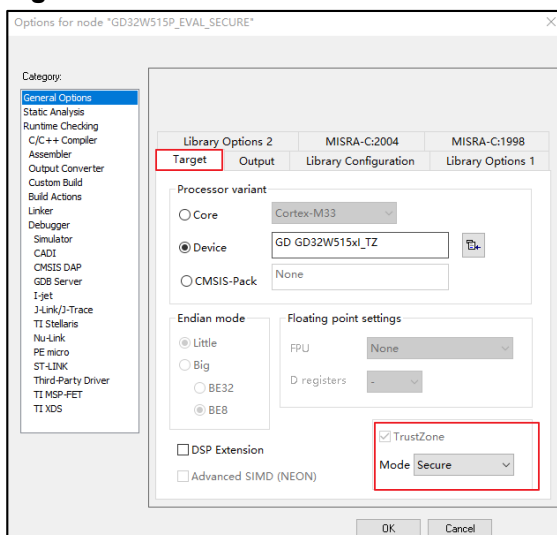
1. Select secure project as active project, as shown in [Figure 3-16. Select secure project](#).

Figure 3-16. Select secure project



2. In Project / Options / General Options / Target, select TrustZone / Mode as Secure, as shown in [Figure 3-17. Select Secure mode](#).

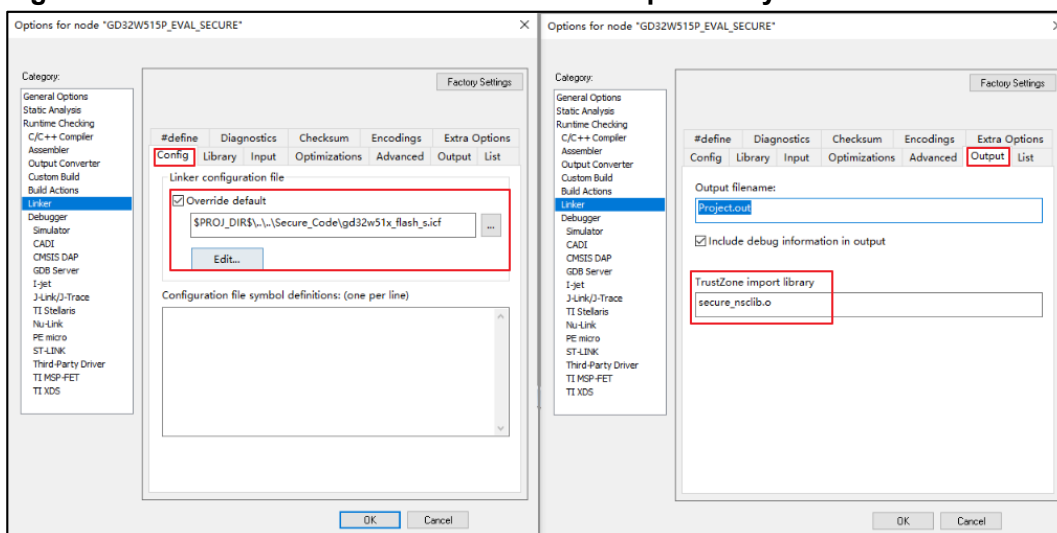
Figure 3-17. Select Secure mode



3. Secure code and non-secure code use different Flash and SRAM, and use a scattered load file to assign the Flash and SRAM for secure code. In Project / Options / Linker / Config, select scattered load file and set the output library for NSC functions. See [Figure 3-18. Select scattered load file and NSC output library](#).

The output command is `--import_cmse_lib_out=.secure_nsclib.o`. The compiler will compile the code at compile time with `__attribute((cmse_nonsecure_entry))` identifying code into `.secure_nsclib.o`. Non-secure code can access functions of `secure_nsclib.o`.

Figure 3-18. Select scattered load file and NSC output library



4. The secure project uses Flash address `0x0C000000` with size `0x40000` and SRAM address `0x30000000` with size `0x10000`. NSC function is assigned to address `0x0C03E000` and size is `0x0002000`. `gd32w51x_flash_s.icf` code is shown in [Table 3-3. gd32w51x_flash_s.icf code](#).

Table 3-3. gd32w51x_flash_s.icf code

<code>/*-Specials-*/</code>

```

define symbol __ICFEDIT_intvec_start__ = 0x0C000000;

/*-Memory Regions-*/

define symbol __ICFEDIT_region_ROM_start__ = 0x0C000000;
define symbol __ICFEDIT_region_ROM_end__   = 0x0C03FFFF;
define symbol __ICFEDIT_region_RAM_start__ = 0x30000000;
define symbol __ICFEDIT_region_RAM_end__   = 0x3000FFFF;

.....

define symbol __region_ROM_NSC_start__     = 0x0C03E000;
define symbol __region_ROM_NSC_end__       = 0x0C03FFFF;

.....

define region ROM_region                    = mem:[from __ICFEDIT_region_ROM_start__ to
__ICFEDIT_region_ROM_end__];
define region ROM_NSC_region                = mem:[from __region_ROM_NSC_start__ to
__region_ROM_NSC_end__];
define region RAM_region                    = mem:[from __ICFEDIT_region_RAM_start__ to
__ICFEDIT_region_RAM_end__];

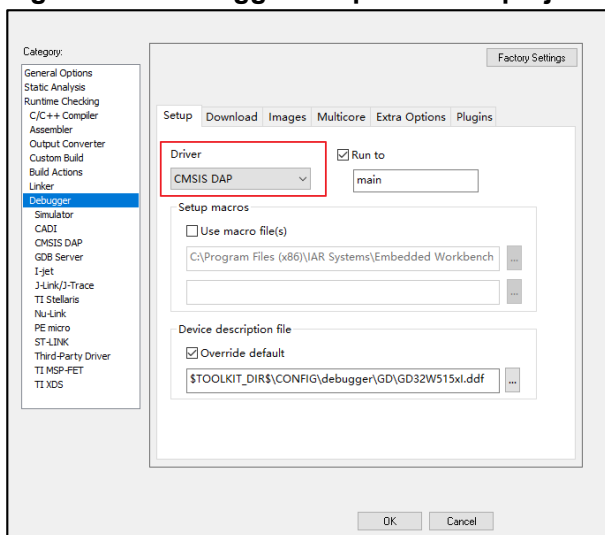
.....

place in ROM_region      { readonly };
place in ROM_NSC_region { section Veneer$$CMSE };
place in RAM_region      { readwrite, block HEAP, block CSTACK };

```

5. Use GD-Link for debugging and downloading. Select CMSIS-DAP under Project / Options / Debugger. See [Figure 3-19. Debugger setup in secure project](#).

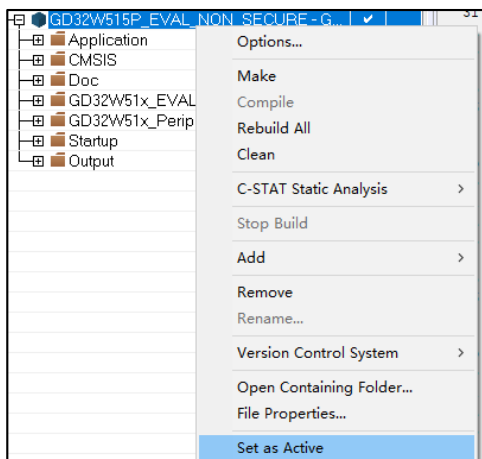
Figure 3-19. Debugger setup in secure project



3.2.2. Non-secure Project

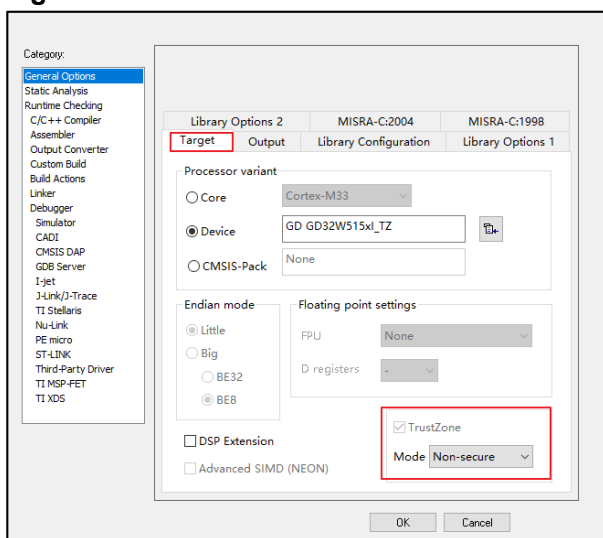
1. Select non-secure project as active project, as shown in [Figure 3-20. Select non-secure project](#).

Figure 3-20. Select non-secure project



2. In Project / Options / General Options / Target, select TrustZone / Mode as Non-secure, as shown in [Figure 3-21. Select non-secure mode](#).

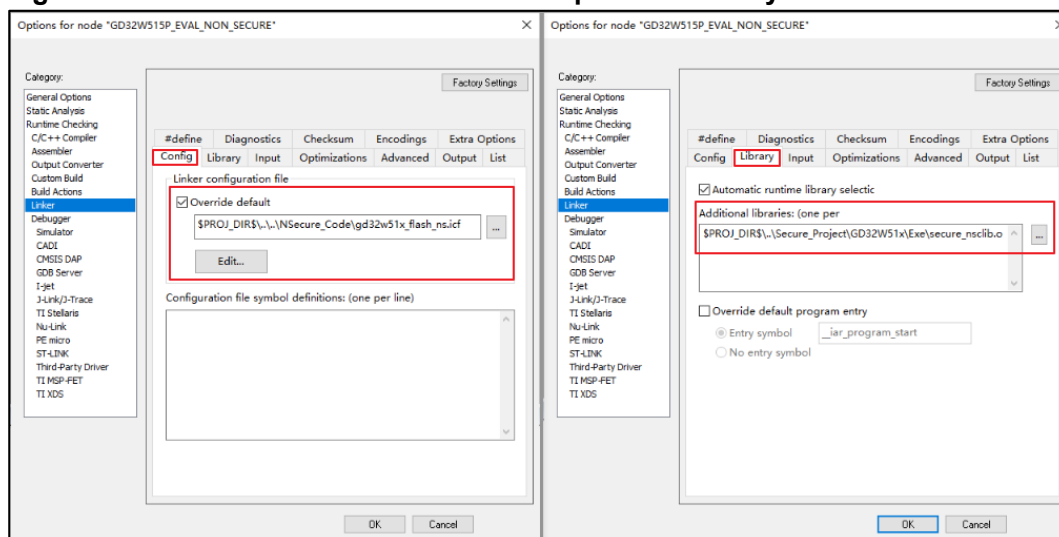
Figure 3-21. Select non-secure mode



3. Secure code and non-secure code use different Flash and SRAM, and use a scattered load file to assign the Flash and SRAM for secure code. In Project / Options / Linker / Config, select scatter load file and use the NSC function library exported by the Security Project. See [Figure 3-22. Select scattered load file and import NSC library](#).

Library import command \$PROJ_DIR\$..\Secure_Project\GD32W51x\Exe\secure_nsc.lib.o, non-secure project can directly call the __attribute((cmse_nonsecure_entry)) identification code in the security project.

Figure 3-22. Select scattered load file and import NSC library



4. Non-secure code uses Flash address 0x08040000 with size 0x001C0000 and SRAM address 0x20010000 with size 0x10000. Project_NS.sct code is shown in [Table 3-4. gd32w51x_flash_ns.icf code](#).

Table 3-4. gd32w51x_flash_ns.icf code

```

/*-Specials-*/
define symbol __ICFEDIT_intvec_start__ = 0x08040000;

/*-Memory Regions-*/
define symbol __ICFEDIT_region_ROM_start__ = 0x08040000;
define symbol __ICFEDIT_region_ROM_end__ = 0x081FFFFFF;
define symbol __ICFEDIT_region_RAM_start__ = 0x20010000;
define symbol __ICFEDIT_region_RAM_end__ = 0x2001FFFF;

.....

define region ROM_region = mem:[from __ICFEDIT_region_ROM_start__ to
__ICFEDIT_region_ROM_end__];
define region RAM_region = mem:[from __ICFEDIT_region_RAM_start__ to
__ICFEDIT_region_RAM_end__];

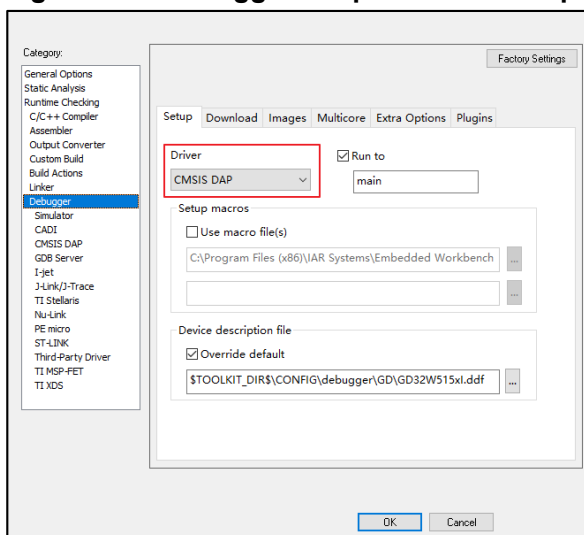
.....

place in ROM_region { readonly };
place in RAM_region { readw rite, block HEAP, block CSTACK};

```

5. Use GD-Link for debugging and downloading. Select CMSIS-DAP under Project / Options / Debugger. See [Figure 3-23. Debugger setup in non-secure project](#).

Figure 3-23. Debugger setup in non-secure project

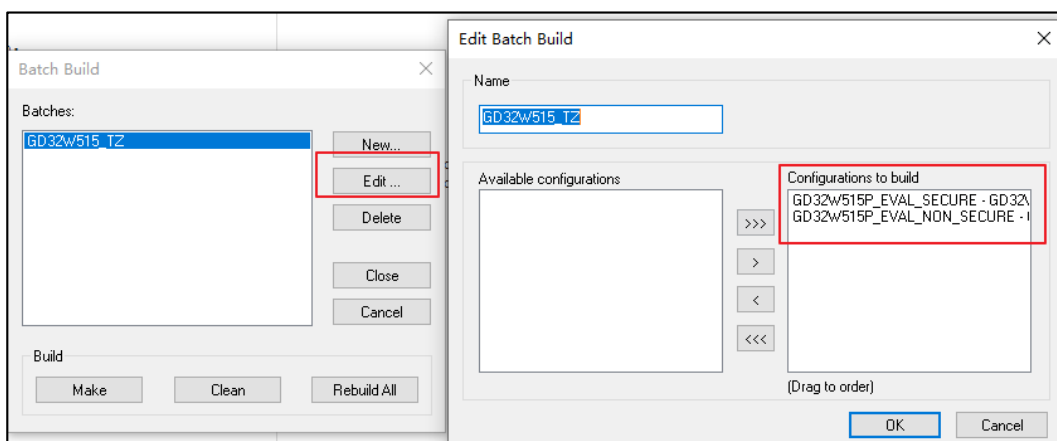


3.2.3. Compile Project

Firstly compile secure project and then non-secure project. Non-secure project need `secure_nsclib.o` library generated in secure project. Compile the secure and insecure projects in order.

Batch setup can also compile two projects in order, as shown in [Figure 3-24. Compile project](#). The order is determined by the order of addition.

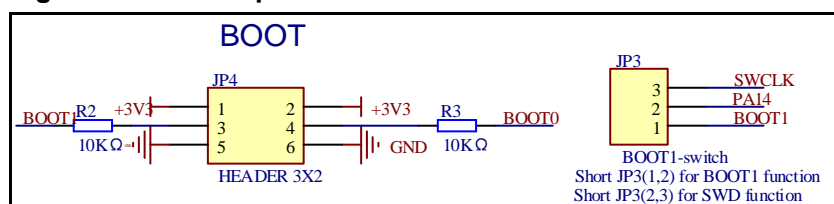
Figure 3-24. Compile project



3.2.4. Download Project

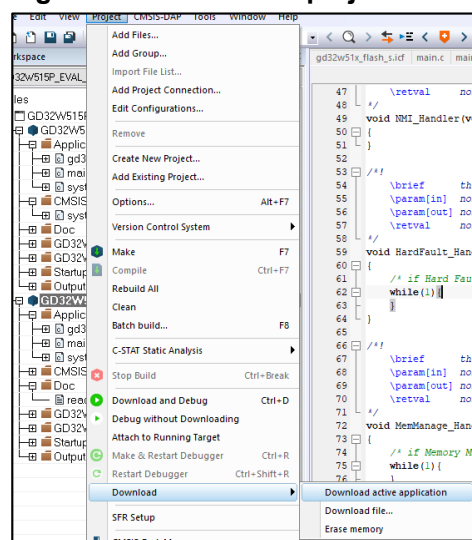
Set up Eval-board correctly before downloading code. JP4 (BOOT0/BOOT1) connects to L MCU will boot from the secure code. JP3 connects to SWD. See [Figure 3-25. Boot option](#). JP21 connects to USART for printf. Connect Eval-board GD-Link and USART to PC, and ensure that software drivers are correctly installed.

Figure 3-25. Boot option



Firstly download non-secure code and then secure code. MCU always boots from secure code and jumps to non-secure code. See [Figure 3-26. Download project](#).

Figure 3-26. Download project



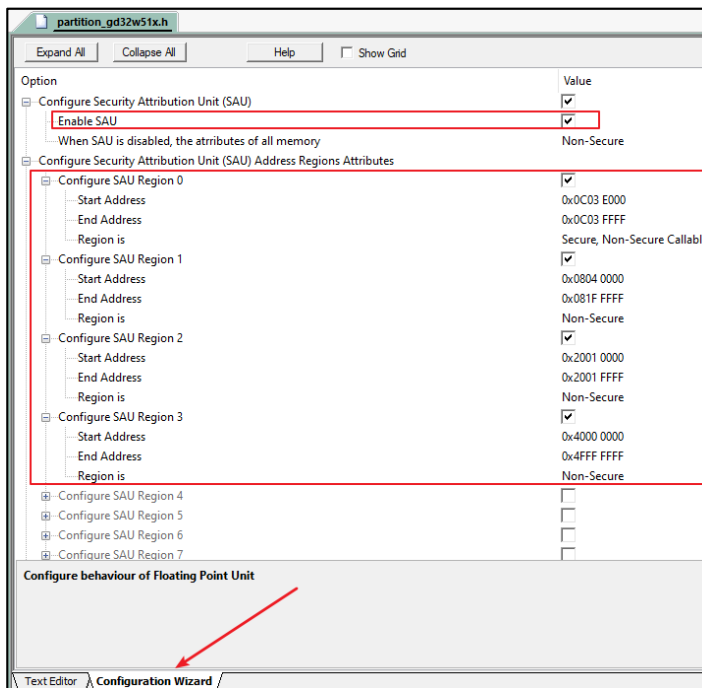
Reset and Run are not checked in the Flash Download option. Press manually Reset button to restart MCU. Two messages will be printed and two LED lights flash respectively.

4. Code interpretation

4.1. Secure Project

If Code Generation/Software Model is set to Secure Mode in the Project/Options for Target/Target TAB, `__ARM_FEATURE_CMSE` is defined as 3. After power-on and reset, MCU will execute `system_gd32w51x.c/SystemInit()/sau_region_config()` function to configure the SAU based on the `partition_gd32w51x.h` content. The `partition_gd32w51x.h` file can be configured using the Configuration Wizard interface and generate Text Editor code. As shown in [Figure 4-1. SAU configuration](#). SAU is enabled and four regions are configured. Region0 configures NSC address, corresponding to `Project_S.sct`. Region1 configures non-secure code address. Region2 configures non-secure SRAM address, corresponding to `Project_NS.sct`. Region3 configures peripheral address to be non-secure. Peripheral can be accessed in both secure or non-secure code.

Figure 4-1. SAU configuration



In main function of secure project, secure interrupt is enabled, SysTick configuration, FMC configuration, TZBMP configuration, LED configuration, USART configuration, and finally jump to non-secure code. See [Table 4-1. main code in secure project](#).

Table 4-1. main code in secure project

```
int main(void)
{
    /* enable SecureFault handler */
    SCB->SHCSR |= SCB_SHCSR_SECUREFAULTENA_Msk;
```

```

/* configure systick */
systick_config();
/* configure mark secure pages */
if((SECM_SPAGE != (FMC_SECMCFG0 & 0x3FF) || SECM_EPAGE != ((FMC_SECMCFG0 >>
16) & 0x3FF)){
    fmc_secmark_config();
}
if(0U == (FMC_OBR & FMC_OBR_TZEN)){
    /* enable trustzone */
    fmc_trustzone_enable();
}
/* configure TZBMPC */
tzbmpc_config();
led_config();
com_config();
/* setup and jump to non-secure */
nonsecure_init();
while(1){
}
}

```

Function `fmc_secmark_config()` configures pages 0-63 of FMC. First 256KB is used for secure code.

Table 4-2. FMC configuration

```

void fmc_secmark_config(void)
{
    fmc_unlock();
    ob_unlock();
    /* configure mark secure pages */
    ob_secmark_config(SECM_SPAGE, SECM_EPAGE, SECM_INDEX0);
    ob_start();
    while(0U != (FMC_SECSTAT & (FMC_SECSTAT_SECBUSY))){
    }
    ob_reload();
    ob_lock();
    fmc_lock();
}

```

Function `tzbmpc_config()` configures SRAM1 as non-secure. This area is used for non-secure code.

Table 4-3. SRAM configuration

```

void tzbmpc_config(void)
{

```

```

uint16_t block_number = 0U;
/* enable TZPCU clock */
rcu_periph_clock_enable(RCU_TZPCU);
/* SRAM1 is used to nonsecure code, so all blocks of SRAM1 should set to nonsecure */
for(block_number = 0U; block_number <= TZBMPC1_BLOCK_NUMBER; block_number++){
    tzpcu_tzbmpc_block_secure_access_mode_config(TZBMPC1, block_number,
BLOCK_SECURE_ACCESS_MODE_NSEC);
}
}

```

Function `led_config()` configures LED1 and LED2 ports as non-secure. LED1 and LED2 will be controlled by non-secure code. Function `com_config()` configures USART2 (serial port) as secure. USART2 will be controlled by secure code.

`entry_cb_func_register()` and `non_secure_print()` are non-secure callable functions marked with `__attribute__((cmse_nonsecure_entry))`. Non-secure code can call these functions directly to pass non-secure function addresses and information to print.

If secure code needs to call non-secure function, use `cmse_nsfptr_create(func_addr)` to register the function address and `__attribute__((cmse_nonsecure_call))` to convert the function to non-secure. Finally use the function. In this demo, non-secure code first calls the `entry_cb_func_register()` to get address of `toggle_led1`, and then calls `nonsecure_func()` to toggle LED1. The code is shown in [Table 4-4. Call non-secure function in secure code](#).

Table 4-4. Call non-secure function in secure code

```

#define CMSE_NS_ENTRY __attribute__((cmse_nonsecure_entry))
#define CMSE_NS_CALL __attribute__((cmse_nonsecure_call))
typedef void CMSE_NS_CALL (*ns_fptr)(void);
ns_fptr nonsecure_func = (ns_fptr)NULL;
.....
CMSE_NS_ENTRY void entry_cb_func_register(void *callback)
{
    if(callback != NULL){
        nonsecure_func = (ns_fptr)cmse_nsfptr_create(callback);
    }
}
}

```

4.2. Non-secure project

NSC functions can be used in non-secure code after imported `secure_nsclib.o` library. In `main()` function, `entry_cb_func_register()` passes address of `toggle_led1` to security code. Then configure SysTick of non-secure domain, initialize LED port. The while loop periodically flips LED2 and calls the NSC function `non_secure_print` to print the information.

Table 4-5. Call secure function in non-secure code

```
extern void entry_cb_func_register(void *callback);
extern void non_secure_print(const char *str);
int main(void)
{
    entry_cb_func_register((void *)toggle_led1);
    /* configure systick */
    systick_config();
    gd_eval_led_init(LED1);
    gd_eval_led_init(LED2);
    while(1){
        /* toggle LED2 */
        gd_eval_led_toggle(LED2);
        non_secure_print("non-secure code toggle LED2.\r\n");
        delay_1ms(1000);
    }
}
```

5. Revision history

Table 5-1. Revision history

Revision No.	Description	Date
1.0	Initial Release	Mar.3 2023

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